Vishay Siliconix



**HVMDIP** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>qs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> (Max.) (nC)

Configuration

GC

P-Channel MOSFET

1.2

-100

8.7

2.2

4.1

Single

 $V_{GS} = -10 V$ 

# **Power MOSFET**

## FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- For automatic insertion
- End stackable
- P-channel
- Fast switching
- 175 °C operating temperature
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD9110PbF

<b>ABSOLUTE MAXIMUM RATINGS (TA :</b>	= 25 °C, unless o	otherwis	e noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	-100	- V		
Gate-source voltage		V <sub>GS</sub>	± 20			
Continuous drain current	$V_{GS}$ at -10 V $T_A = 25 \degree C$ $T_A = 100 \degree C$			-0.70		
Continuous drain current	$V_{GS}$ at -10 V $T_A =$	= 100 °C	I <sub>D</sub>	-0.49	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	-5.6	1	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub> 140		mJ		
Repetitive avalanche current <sup>a</sup>		I <sub>AR</sub>	-0.7	А		
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	0.13	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$		P <sub>D</sub>	1.3	W		
Peak diode recovery dv/dt <sup>c</sup>		dV/dt	-5.5	V/ns		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to + 175			
Soldering rRecommendations (peak temperature) <sup>d</sup>	For 10 s			300 <sup>d</sup>		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = -25 V, starting T<sub>J</sub> = 25 °C, L = 52 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = -2.0 A (see fig. 12)

c.  $I_{SD} \le -4.0$  A, dI/dt  $\le 75$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C

d. 1.6 mm from case

S21-0887-Rev. D, 30-Aug-2021

For technical questions, contact: hvm@vishay.com





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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.	1	MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 120			°C/W			
<b>SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ , u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = -2	250 µA	-100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = -1 mA	-	-0.091	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = -$	250 µA	-2.0	-	-4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20$	V	-	-	± 100	nA
Zero Gate Voltage Drain Current	1	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	-100		
Zero Gale Voltage Drain Gurrent	IDSS	V <sub>DS</sub> = -80 V	, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 150 °C	-	-	-500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}$	I <sub>D</sub> =	= -0.42 A <sup>b</sup>	-	-	1.2	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	-50 V, I <sub>D</sub> =	-0.42 A	0.60	-	-	S
Dynamic								•
Input Capacitance	C <sub>iss</sub>		-	200	-	pF		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$ $V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5			-		94	-
Reverse Transfer Capacitance	C <sub>rss</sub>				-		18	-
Total Gate Charge	Qg				-	-	8.7	nC
Gate-Source Charge	$Q_gs$	$V_{GS} = -10 V$ $I_D = -4.0 A, V_{DS} = -80 V$ see fig. 6 and 13 <sup>b</sup>			-	-	2.2	
Gate-Drain Charge	$Q_{gd}$				-	-	4.1	
Turn-On Delay Time	t <sub>d(on)</sub>				-	10	-	
Rise Time	t <sub>r</sub>		-50 V, I <sub>D</sub> =		-	27	-	1
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{g} = 24 \Omega, R_{D} = 11 \Omega, $ see fig. 10 <sup>b</sup> - 15		-	ns			
Fall Time	t <sub>f</sub>				-	17	-	1
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	nH	
Internal Source Inductance	L <sub>S</sub>			-	6.0	-		
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-0.70	A		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	-5.6		
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C,	I <sub>S</sub> = -0.7 A	$V_{GS} = 0 V^{b}$	-	-	-5.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C I	10 A di	/dt = 100 A/µs <sup>b</sup>	-	82	160	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$J = 23  \text{O}, \text{I}_{\text{F}}$	– -4.0 A, UI	$\mu at = 100 A/\mu S^{5}$	-	0.15	0.30	μC

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq 300~\mu s;~duty~cycle \leq 2~\%$ 

Document Number: 91138



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

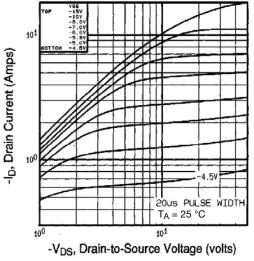
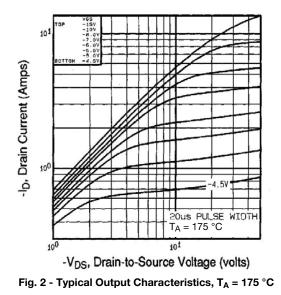
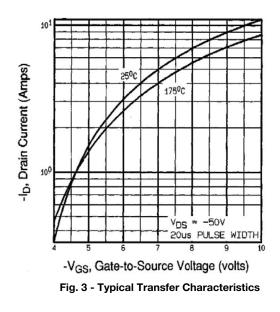


Fig. 1 - Typical Output Characteristics,  $T_A = 25 \ ^{\circ}C$ 





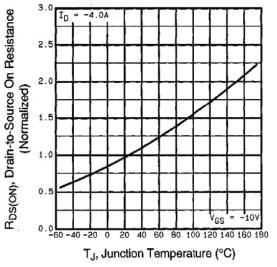


Fig. 4 - Normalized On-Resistance vs. Temperature



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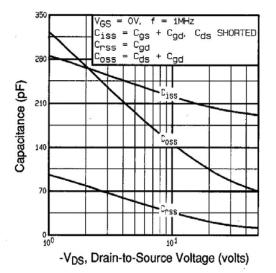


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

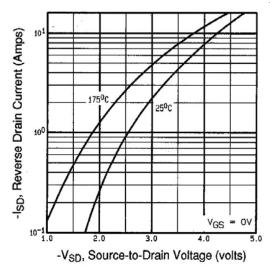


Fig. 7 - Typical Source-Drain Diode Forward Voltage

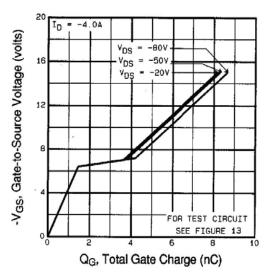
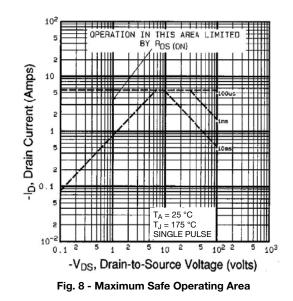


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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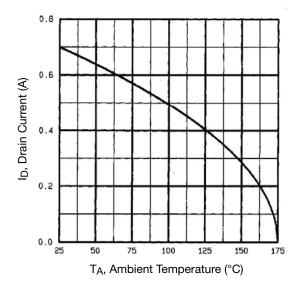


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

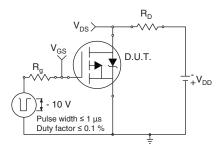


Fig. 10a - Switching Time Test Circuit

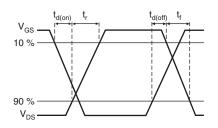


Fig. 10b - Switching Time Waveforms

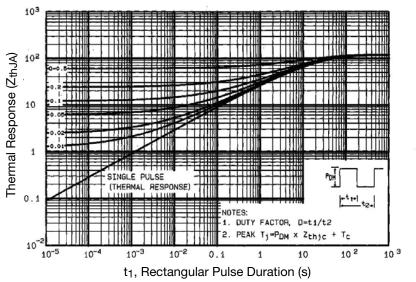


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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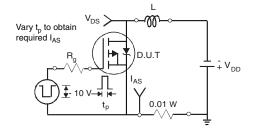


Fig. 12a - Unclamped Inductive Test Circuit

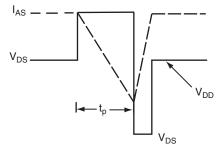


Fig. 12b - Unclamped Inductive Waveforms

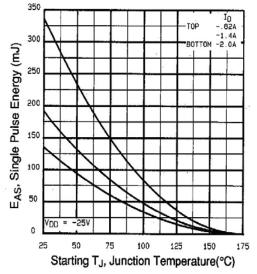


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

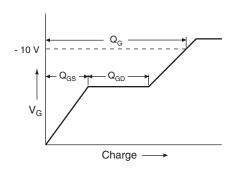


Fig. 13a - Basic Gate Charge Waveform

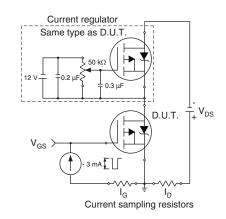


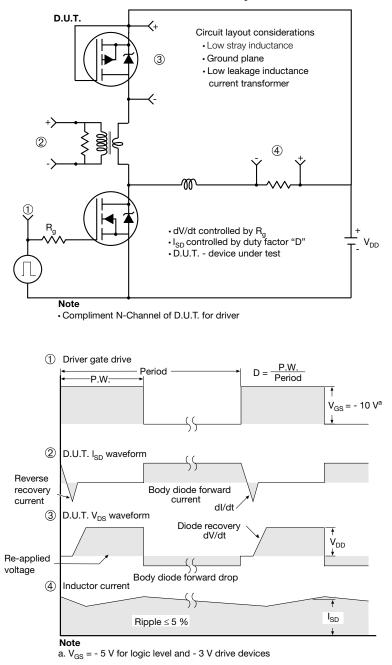
Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



#### Fig. 14 - For P-Channel

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### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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